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## Revision history

**Table 1. Document revision history**

| Date        | Version | Changes   |
|-------------|---------|---|
| 24-Aug-2015 | 1       | Initial release.  |
| 25-Feb-2016 | 2       | Addition of main heading "LICENSE AGREEMENT". Minor formatting changes.               |
| 20-Oct-2017 | 3       | General change.   |
| 07-Mar-2018 | 4       | Alignment of document format with the new standard. No change in the license content. |